

ABSTRACT OF THE DISCLOSURE

A resinous curable composition comprises:

- (A) an epoxy resin;
 - (B) at least carboxylic acid anhydride;
 - 5 (C) at least one inorganic filler, wherein at least 80% of the particles of the filler have a particle diameter size between about 10 to about 40 microns; and
 - (D) at least one inorganic filler, wherein at least 80% of the particles of the filler have a particle diameter size greater than about 90 microns and is preferably either sand and/or granite chips.
- 10 The curable composition may be hardened in the presence of a heat activated catalyst to render a scratch resistant hard surface, suitable for use as a countertop or laboratory bench top. The composition may contain as high as 89% inorganic filler.